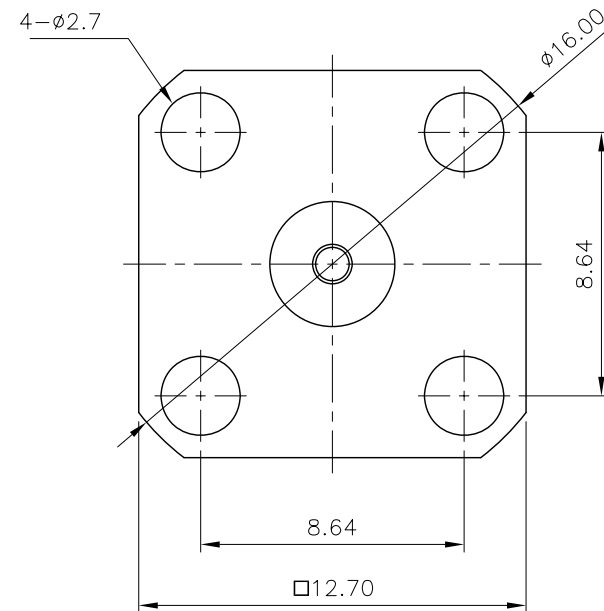
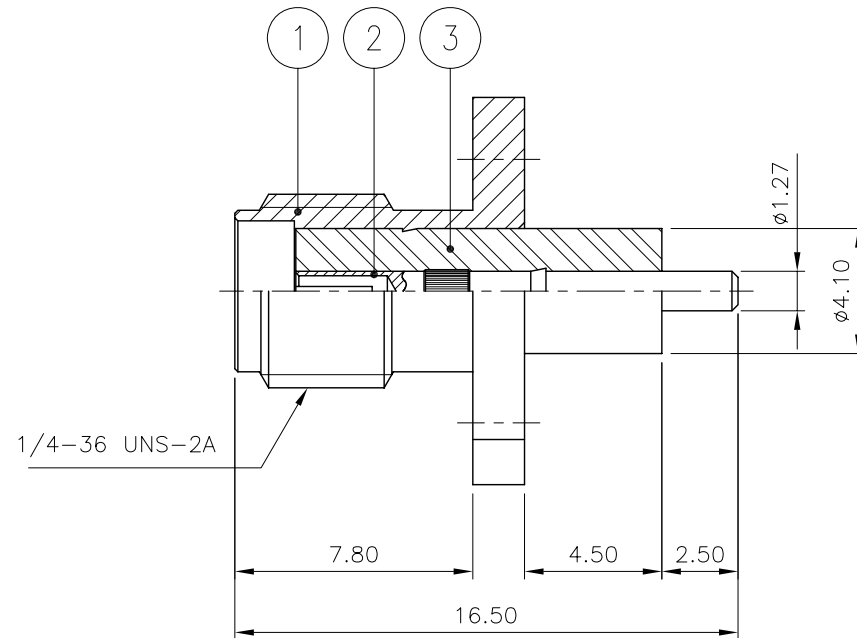


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	M.H.SONG	I.C.KIM	2014.03.20.



3	INSULATOR	1	TEFLON		DIN00123-N/1
2	CONTACT	1	BeCu	Silver 3.0μm min.	DCT02344-5/2
1	BODY	1	MBsBD	SUCO 3.0μm min.	DBD00363-5/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

* ELECTRICAL SPECIFICATIONS
Frequency Range : DC~3GHz
Impedance : 50Ω(Nominal)
PIMD : 145dBc @ 27dBm

TOLERANCE	Decimal ±0.1	DATE 2014. 03. 20.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	E.H.KIM	KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JS-4H
		DRAWN BY	M.H.SONG	
FINISH		SCALE	5/1	A4 DWG NO. CN03193-7/1 REVISION I R SHEET 1 of 1
		UNIT	mm	